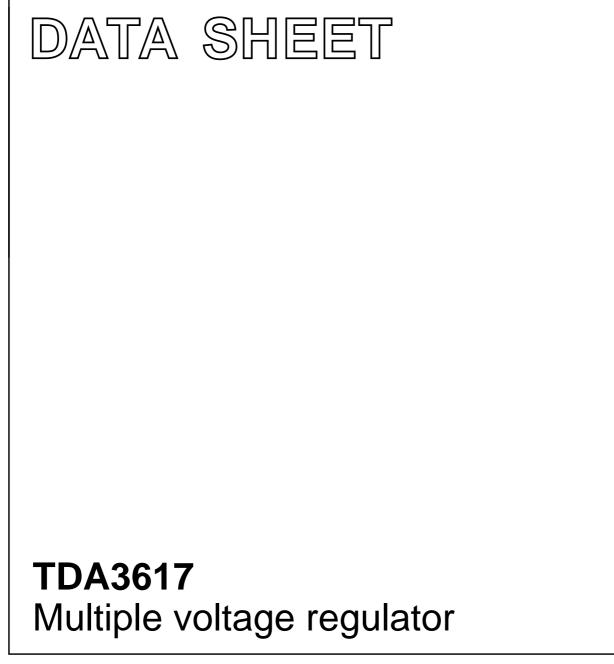
INTEGRATED CIRCUITS



Product specification Supersedes data of 2002 Sep 16 2002 Sep 20



HILIP

TDA3617

FEATURES

General

- Three V_P-state controlled regulators (regulators 1, 2 and 3)
- Very good stability and noise behaviour
- Separate control pins for switching regulators 1, 2 and 3
- Supply voltage range from -18 to +50 V
- Low quiescent current (when regulators 1, 2 and 3 are switched off)
- High ripple rejection
- Hold output for indicating regulator 1 and/or 2 and/or 3 out-of-regulation.

Protections

- Reverse polarity safe (down to -18 V without high reverse current)
- Able to withstand voltages up to 18 V at the outputs (supply line may be short circuited)
- · ESD protection on all pins

QUICK REFERENCE DATA

- Thermal protection
- Load dump protection
- Foldback current limit protection for regulators 1, 2 and 3
- DC short-circuit safe to ground and V_{P} for all regulator outputs.

GENERAL DESCRIPTION

The TDA3617 is a multiple output voltage regulator with three independent regulators. It contains:

- 1. Three fixed voltage regulators with foldback current protection (regulators 1, 2 and 3)
- 2. A supply pin that can withstand load dump pulses and negative supply voltages
- 3. Independent enable inputs for regulators 1, 2 and 3
- 4. Local temperature protection for regulator 3
- 5. A hold output that can be used to interface with a microprocessor. The hold indicates that the selected output voltages are available and within their ranges.

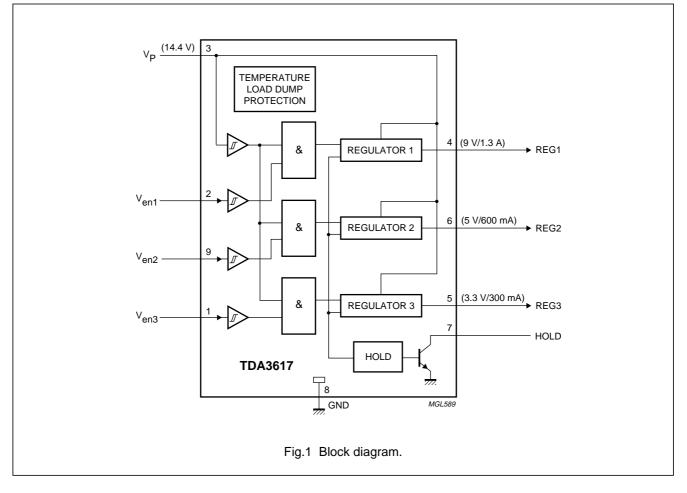
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply		•	•	•		
V _P	supply voltage					
	operating		9.5	14.4	17.5	V
	jump start	t ≤ 10 minutes	-	-	30	V
	load dump protection	for 50 ms; $t_r \ge 2.5$ ms	-	-	50	V
I _{q(tot)}	total quiescent current	standby mode	-	5	40	μA
Tj	junction temperature		-	-	175	°C
Voltage regu	lators			-		_
V _{REG1}	output voltage regulator 1	$1 \text{ mA} \le I_{\text{REG1}} \le 1.3 \text{ A}$	8.55	9.0	9.45	V
V _{REG2}	output voltage regulator 2	$1 \text{ mA} \le I_{REG2} \le 600 \text{ mA}$	4.75	5.0	5.25	V
V _{REG3}	output voltage regulator 3	$1 \text{ mA} \le I_{\text{REG3}} \le 300 \text{ mA}$	3.14	3.3	3.46	V

ORDERING INFORMATION

TYPE	PACKAGE			
NUMBER	NAME	DESCRIPTION	VERSION	
TDA3617J	DBS9P	plastic DIL-bent-SIL power package; 9 leads (lead length 12 mm)	SOT157-2	

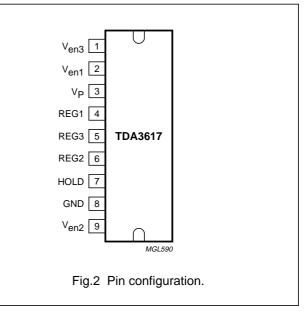
TDA3617

BLOCK DIAGRAM



PINNING

SYMBOL	PIN	DESCRIPTION		
V _{en3}	1	enable regulator 3 input		
V _{en1}	2	enable regulator 1 input		
V _P	3	supply voltage		
REG1	4	regulator 1 output		
REG3	5	regulator 3 output		
REG2	6	regulator 2 output		
HOLD	7	hold output		
GND	8	ground		
V _{en2}	9	enable regulator 2 input		



TDA3617

FUNCTIONAL DESCRIPTION

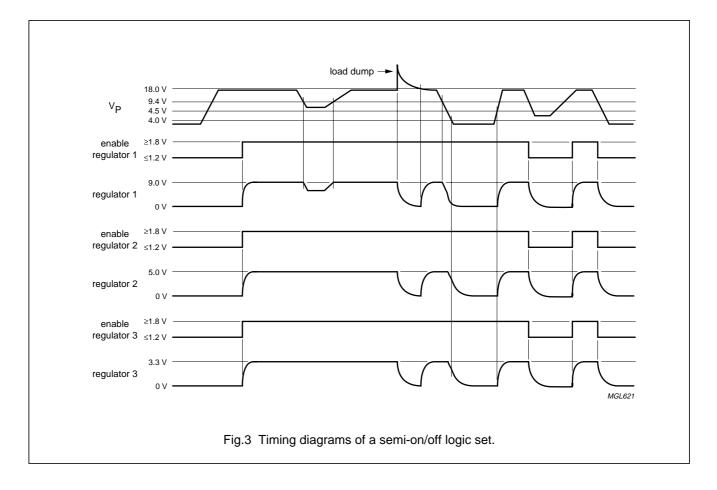
The TDA3617 is a multiple output voltage regulator with three independent switchable regulators. When the supply voltage is available ($V_P > 4.5$ V), regulators 1, 2 and 3 can be operated by means of three independent enable inputs.

Schmitt trigger functions are included to switch the regulators off at low battery voltage ($V_P < 4 \text{ V}$). A hysteresis is included to avoid random switching.

All output pins are fully protected. The regulators are protected against load dump (the regulators switch off at $V_P > 20$ V) and short circuit (foldback current protection).

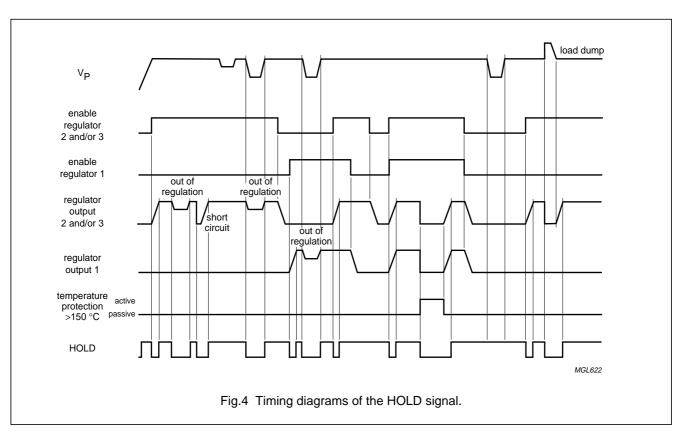
The TDA3617 has a hold circuit which indicates when one of the regulators is out-of-regulation. The hold function is disabled when all the enable inputs are LOW (TDA3617 in standby mode). The HOLD output (open-collector output) can be wired OR-ed with other hold outputs of other regulator parts (e.g. TDA3618). When all the regulators of the TDA3617 are disabled (switched off), the HOLD output will be high ohmic. Because of this feature, the hold will not influence the hold information when wired OR-ed with other regulator parts.

Figure 3 shows the total timing of a semi-on/off logic set. Figure 4 shows the total timing of the HOLD signal.



Product specification

TDA3617



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _P	supply voltage				
	operating		-	17.5	V
	jump start	t ≤ 10 minutes	_	30	V
	load dump protection	for 50 ms; $t_r \ge 2.5$ ms	_	50	V
V _{bat(rp)}	reverse polarity battery voltage	non-operating	-	-18	V
P _{tot}	total power dissipation		_	62	W
T _{stg}	storage temperature	non-operating	-55	+150	°C
T _{amb}	ambient temperature	operating	-40	+85	°C
Tj	junction temperature	operating	-	175	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-c)}	thermal resistance from junction to case		2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	50	K/W

QUALITY SPECIFICATION

In accordance with "SNW-FQ-611-E".

2002 Sep 20

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CHARACTERISTICS

 V_{P} = 14.4 V; T_{amb} = 25 °C; measured in test circuit of Fig.6; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supplies					1	
V _P	supply voltage					
	operating		9.5	14.4	17.5	V
	regulators on	note 1	6	_	_	V
	jump start	t ≤ 10 minutes	_	_	30	V
	load dump protection	for 50 ms; $t_r \ge 2.5$ ms	_	_	50	V
I _{q(tot)}	total quiescent current	V _P = 12.4 V; note 2	_	5	40	μA
		V _P = 14.4 V; note 2	_	5	-	μA
Power supp	ply Schmitt trigger for regula	ators 1, 2 and 3	•	•		
V _{thr}	rising voltage threshold	V _{en} = 3 V	6.2	6.8	7.5	V
V _{thf}	falling voltage threshold	V _{en} = 3 V	4.0	4.5	5.0	V
V _{hys}	hysteresis		1.5	2.3	3.0	V
	ut (regulators 1, 2 and 3)	1		1	1	
V _{i(off)}	off-level input voltage		-0.2		+1.2	V
V _{i(on)}	on-level input voltage		_	1.8	_	V
	input leakage current	V _{en} = 5 V	5	30	50	μA
Hold buffer				1		· ·
I _{sinkL}	LOW-level sink current	$V_{HOLD} \le 0.8 V$	2	_	_	mA
ILO	output leakage current	$V_{HOLD} = 5 V$	_	0	5	μA
	l (I _{REG1} = 5 mA)	1.025		1		
V _{REG1(off)}	output voltage regulator off		_	1	400	mV
V _{REG1}	output voltage	$1 \text{ mA} \leq I_{\text{REG1}} \leq 1.3 \text{ A}$	8.55	9.0	9.45	V
REGI		$10.5 \text{ V} \le \text{V}_{\text{P}} \le 17.5 \text{ V}$	8.55	9.0	9.45	V
ΔV_{REG1}	line regulation	10.5 V ≤ V _P ≤ 17.5 V	_	20	50	mV
ΔV_{REGL1}	load regulation	$1 \text{ mA} \le I_{\text{REG1}} \le 1.3 \text{ A}$	_	35	70	mV
I _{qREG1}	quiescent current	I _{REG1} = 1.3 A	_	45	110	mA
SVRR1	supply voltage ripple rejection	$f = 3 \text{ kHz}; V_i = 2 \text{ V (p-p)}$	60	70	-	dB
V _{REG1d}	drop-out voltage	I _{REG1} = 1.3 A; note 3	_	0.5	1	V
I _{REG1m}	current limit	V _{REG1} > 7.5 V; note 4	1.3	1.4	_	A
I _{REG1sc}	short-circuit current	$R_{L} \leq 0.5 \Omega$; note 5	250	500	_	mA
α _{ct}	cross talk noise	note 6	_	25	150	μV
	gger for hold of regulator 1	1	I	1	ļ	
V _{thr}	rising threshold voltage of regulator 1	V _P rising	-	V _{REG1} - 0.15	V _{REG1} - 0.075	V
V _{thf}	falling threshold voltage of regulator 1	V _P falling	8.1	V _{REG1} – 0.35	-	V
V _{hys}	hysteresis voltage		0.1	0.2	0.3	V
,-	· · ·	1		1	1	1

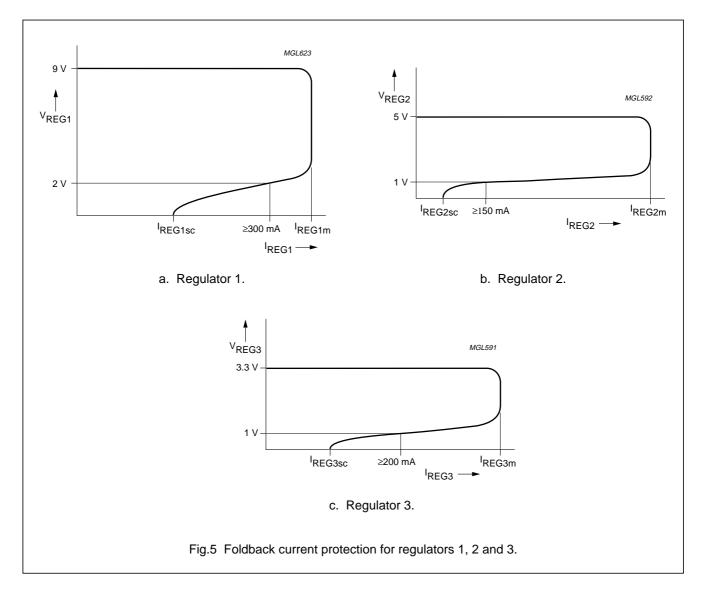
TDA3617

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Regulator 2	2 (I _{REG2} = 5 mA)			1	Į	1
V _{REG2(off)}	output voltage regulator off		-	1	400	mV
V _{REG2}	output voltage	$1 \text{ mA} \le I_{\text{REG2}} \le 600 \text{ mA}$	4.75	5.0	5.25	V
		$8 \text{ V} \le \text{V}_{\text{P}} \le 17.5 \text{ V}$	4.75	5.0	5.25	V
ΔV_{REG2}	line regulation	$8 \text{ V} \le \text{V}_{\text{P}} \le 17.5 \text{ V}$	_	2	50	mV
ΔV_{REGL2}	load regulation	$1 \text{ mA} \le I_{REG2} \le 600 \text{ mA}$	-	20	85	mV
I _{qREG2}	quiescent current	I _{REG2} = 0.4 A	-	10	40	mA
SVRR2	supply voltage ripple rejection	f = 3 kHz; V _i = 2 V (p-p)	60	70	-	dB
V _{REG2d}	drop-out voltage	$I_{REG2} = 600 \text{ mA}; V_P = 6 \text{ V};$ note 3	-	1	1.5	V
I _{REG2m}	current limit	V _{REG2} > 4 V; note 4	0.65	0.8	-	А
I _{REG2sc}	short-circuit current	$R_L \le 0.5 \Omega$; note 5	100	300	_	mA
α_{ct}	cross talk noise	note 6	_	25	150	μV
Schmitt trig	ger for hold of regulator 2					
V _{thr}	rising threshold voltage of regulator 2	V _P rising	-	V _{REG2} – 0.15	V _{REG2} - 0.075	V
V _{thf}	falling threshold voltage of regulator 2	V _P falling	4.3	V _{REG2} – 0.35	-	V
V _{hys}	hysteresis voltage		0.1	0.2	0.3	V
Regulator 3	3 (I _{REG3} = 5 mA)		•		1	
V _{REG3(off)}	output voltage regulator off		_	1	400	mV
V _{REG3}	output voltage	$1 \text{ mA} \le I_{\text{REG3}} \le 300 \text{ mA}$	3.14	3.3	3.46	V
		$5 \text{ V} \le \text{V}_{\text{P}} \le 17.5 \text{ V}$	3.14	3.3	3.46	V
ΔV_{REG3}	line regulation	$5 \text{ V} \le \text{V}_{P} \le 17.5 \text{ V}$	-	2	50	mV
ΔV_{REGL3}	load regulation	$1 \text{ mA} \le I_{REG3} \le 300 \text{ mA}$	-	20	50	mV
I _{qREG3}	quiescent current	I _{REG3} = 300 mA	-	10	15	mA
SVRR3	supply voltage ripple rejection	f = 3 kHz; V _i = 2 V (p-p)	60	70	-	dB
I _{REG3m}	current limit	V _{REG3} > 3 V; note 4	0.35	0.45	-	А
I _{REG3sc}	short circuit current	$R_L \le 0.5 \Omega$; note 5	15	50	-	mA
α_{ct}	cross talk noise	note 6	_	25	150	μV
Schmitt trig	ger for hold of regulator 3					
V _{thr}	rising threshold voltage of regulator 3	V _P rising	-	V _{REG3} – 0.15	V _{REG3} - 0.075	V
V _{thf}	falling threshold voltage of regulator 2	V _P falling	2.7	V _{REG3} – 0.35	-	V
			-			

Notes

1. Minimum operating voltage, only if V_{P} has exceeded 4.5 V.

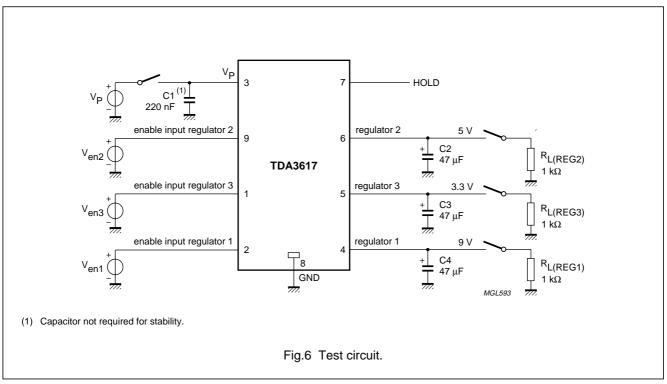
- The quiescent current is measured in the standby mode. Therefore, the enable inputs of regulators 1, 2 and 3 are LOW (V_{en} < 1 V).
- 3. The drop-out voltage of regulators 1 and 2 is measured between V_P and V_{REG1} or V_{REG2} respectively.
- 4. At current limit, I_{REGmn} is held constant (see Fig.5 for the behaviour of I_{REGmn}).
- 5. The foldback current protection limits the dissipated power at short circuit (see Fig.5).
- 6. Perform the load regulation test with sine wave load of 10 kHz on the regulator output under test. Measure the RMS ripple voltage on each of the remaining regulator outputs, using a 80 kHz low-pass filter.



TDA3617

TEST AND APPLICATION INFORMATION

Test information



Application information

NOISE

Table 1 Noise figures

REGULATOR	NOISE FIGURE (μV) ⁽¹⁾				
REGULATOR	C _o = 10 μF	$C_o = 47 \ \mu F$	$C_o = 100 \ \mu F$		
1	190	170	140		
2	120	110	80		
3	100	90	70		

Note

1. Measured at a bandwidth of 200 kHz.

The noise on the supply line depends on the value of the supply capacitor and is caused by a current noise (output noise of the regulators is translated to a current noise by means of the output capacitors). The noise is minimum when a high frequency capacitor of 220 nF in parallel with an electrolytic capacitor of 100 μF is connected directly to pins 3 and 8 (supply and ground).

STABILITY

The regulators are stabilized with the externally connected output capacitors. The value of the output capacitors can be selected by referring to the graph illustrated in Fig.7.

When an electrolytic capacitor is used, its temperature behaviour can cause oscillations at T_{amb} < -20 °C. In this case, use a tantalum capacitor.

The two examples on the next page show how an output capacitor value is selected.

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Example 1

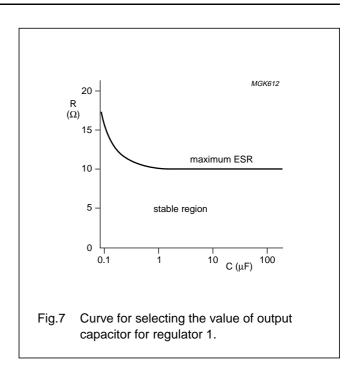
Regulators 1, 2 and 3 are stabilized with an electrolytic output capacitor of 220 μF (ESR = 0.15 Ω). At T_{amb} = -30 °C the capacitor value is decreased to 73 μF and the ESR is increased to 1.1 Ω . The regulator will remain stable at T_{amb} = -30 °C.

Example 2

Regulators 1, 2 and 3 are stabilized with an electrolytic output capacitor of 10 μ F (ESR = 3.18 Ω). At T_{amb} = -30 °C the capacitor value is decreased to 3.3 μ F and the ESR is increased to 23 Ω . The regulator will be instable at T_{amb} = -30 °C.

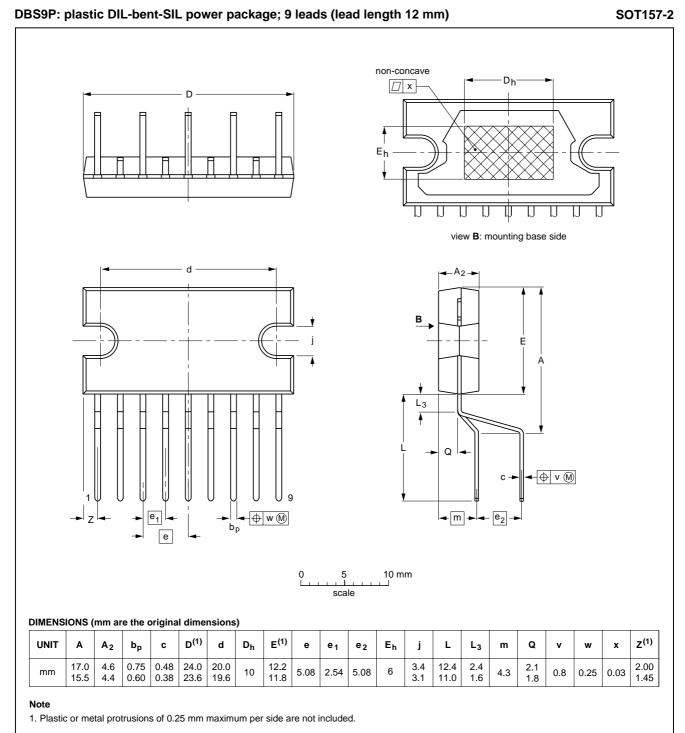
Solution

Use a 47 nF HF capacitor in parallel with the output electrolytic output capacitor. As can be seen from the graph in Fig.7, the regulators will remain stable with an output capacitor of 47 nF onwards. The electrolytic output capacitor is only needed to minimize the output noise.



TDA3617

PACKAGE OUTLINE



OUTLINE		REFERENCES			EUROPEAN ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT157-2						97-12-16 99-12-17

TDA3617

SOLDERING

Introduction to soldering through-hole mount packages

This text gives a brief insight to wave, dip and manual soldering. A more in-depth account of soldering ICs can be found in our *"Data Handbook IC26; Integrated Circuit Packages"* (document order number 9398 652 90011).

Wave soldering is the preferred method for mounting of through-hole mount IC packages on a printed-circuit board.

Soldering by dipping or by solder wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joints for more than 5 seconds.

The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg(max)}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Manual soldering

Apply the soldering iron (24 V or less) to the lead(s) of the package, either below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 $^{\circ}$ C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 $^{\circ}$ C, contact may be up to 5 seconds.

Suitability of through-hole mount IC packages for dipping and wave soldering methods

PACKAGE	SOLDERING METHOD		
FACKAGE	DIPPING	WAVE	
DBS, DIP, HDIP, SDIP, SIL	suitable	suitable ⁽¹⁾	

Note

1. For SDIP packages, the longitudinal axis must be parallel to the transport direction of the printed-circuit board.

TDA3617

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Product specification

Multiple voltage regulator

TDA3617

NOTES

Product specification

Multiple voltage regulator

TDA3617

NOTES

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